General Description

The MAX4644 is a single-pole/double-throw (SPDT) switch that operates from a single supply ranging from +1.8V to +5.5V. It provides low 4 Ω on-resistance (R_{ON}) as well as 1 Ω R_{ON} flatness over the entire analog signal range. The MAX4644 offers fast switching times of less than 20ns while ensuring break-before-make operation. It typically consumes only 0.01 μ W of quiescent power, making it suitable for use in low-power, portable applications.

The MAX4644's features include low leakage currents over the entire temperature range, TTL/CMOS-compatible digital logic, and excellent AC characteristics. It is packaged in either a small 8-pin μ MAX or a tiny 6-pin SOT23.

Applications

Battery-Operated Equipment

Audio and Video Signal Routing

Rail-to-Rail is a trademark of Nippon Motorola, Ltd.

Low-Voltage Data-Acquisition Systems

Sample-and-Hold Circuits

Communications Circuits

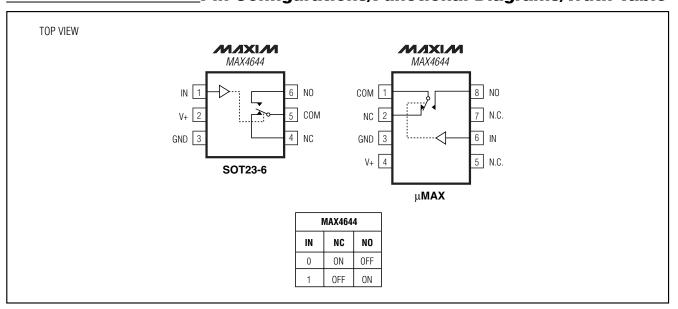
Features

- +1.8V to +5.5V Single-Supply Operation
- ◆ Rail-to-Rail[®] Analog Signal Range
- Guaranteed Ron 4Ω max (+5V supply) 8Ω max (+3V supply)
- +1.8V Operation
 R_{ON} 30Ω typ Over Temperature
 t_{ON} 18ns typ, t_{OFF} 12ns typ
- Guaranteed Ron Flatness: 0.75Ω typ (+5V supply)
- Guaranteed Ron Match Between Channels: 0.1Ω typ (+5V supply)
- Low Leakage (<0.35nA) Over Entire Temperature Range
- Excellent AC Characteristics Low Crosstalk: -82dB at 1MHz High Off-Isolation: -80dB at 1MHz 0.018% Total Harmonic Distortion
- ♦ Low Power Consumption: < 0.01µW</p>

Ordering Information

PART	TEMP. RANGE	PIN- PACKAGE	TOP MARK	
MAX4644EUT-T	-40°C to +85°C	6 SOT23-6	AAHQ	
MAX4644EUA	-40°C to +85°C	8 µMAX	_	

_Pin Configurations/Functional Diagrams/Truth Table



_ Maxim Integrated Products 1

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ABSOLUTE MAXIMUM RATINGS

All Voltages Referenced to GND

V+	-0.3V to +6V
IN, COM, NO, NC (Note 1)	
Continuous Current (any terminal)	±20mÁ
Continuous Current (NO, NC, and COM)	±50mA
Peak Current (NO, NC, and COM, pulsed	at 1ms,
10% duty cycle)	±100mA

Note 1: Signals on NO, NC, COM, or IN exceeding V+ or GND are clamped by internal diodes. Limit forward-diode current to maximum current rating.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS—Single +5V Supply

 $(V_{+} = +4.5V \text{ to } +5.5V, V_{INH} = 2.4V, V_{INL} = 0.8V, T_{A} = T_{MIN} \text{ to } T_{MAX}$, unless otherwise noted. Typical values are at $T_{A} = +25^{\circ}C.$)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
ANALOG SWITCH	•			•			
Analog Signal Range	Vcom, V _{NO} , V _{NC}			0		V+	V
On-Resistance		$V_{+} = 4.5V, I_{COM} = 10mA$	$T_A = +25^{\circ}C$		2.5	4	
On-Resistance	R _{ON}	10mA, V_{NO} or $V_{NC} = 0$ to V+	$T_A = T_{MIN}$ to T_{MAX}			4.75	Ω
On-Resistance Match	ADout	$V_{+} = 4.5V, I_{COM} =$	$T_A = +25^{\circ}C$		0.1		0
Between Channels (Note 2)	ΔRon	10mA, V_{NO} or $V_{NC} = 0$ to V+	TA = TMIN to TMAX			0.4	Ω
On-Resistance Flatness (Note 3)	D=:	$V_{+} = 4.5V, I_{COM} =$			0.75	1	Ω
	R _{FLAT}	10mA, V_{NO} or $V_{NC} = 0$ to V+	TA = TMIN to TMAX			1.2	
NO, NC Off-Leakage	I _{NO(OFF)} ,	$\begin{array}{l} V+=5.5V, \ V_{COM}=\\ 1V \ or \ 4.5V, \ V_{NO} \ or \\ V_{NC}=4.5V \ or \ 1V \end{array}$	T _A = +25°C	-0.25	0.01	0.25	- nA
Current (Note 4)	INC(OFF)		$T_A = T_{MIN}$ to T_{MAX}	-0.35		0.35	
COM Off-Leakage Current		$V_{+} = 5.5V, V_{COM} =$	$T_A = +25^{\circ}C$	-0.25	0.01	0.25	nA
(Note 4)	ICOM(OFF)	1V or 4.5V, V _{NO} or V _{NC} = 4.5V or 1V	$T_A = T_{MIN}$ to T_{MAX}	-0.35		0.35	ΠΑ
COM On-Leakage Current	ICOM(ON)	V+ = 5.5V, V _{COM} =	$T_A = +25^{\circ}C$	-0.25	0.01	0.25	nA
(Notes 4, 5)		1V or 4.5V TA = TMIN to TMAX		-0.35		0.35	
DIGITAL INPUTS							
Input Logic High	VIH			2.4			V
Input Logic Low	VIL					0.8	V
Input Current	lin	$V_{IN} = 0.8V \text{ or } 2.4V$		-0.1	0.005	0.1	μA

///XI//

ELECTRICAL CHARACTERISTICS — Single +5V Supply (continued)

 $(V + = +4.5V \text{ to } +5.5V, V_{INH} = 2.4V, V_{INL} = 0.8V, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted}. Typical values are at T_A = +25°C.)$

PARAMETER	SYMBOL	CONDITIONS		MIN	ТҮР	MAX	UNITS
DYNAMIC				1			1
Turn-On Time (Note 4)	tou	$R_{L} = 300\Omega; C_{L} =$	$T_A = +25^{\circ}C$		11	15	ns
	ton	35pF; V _{NO} , V _{NC} = 3V; Figure 2	$T_A = T_{MIN}$ to T_{MAX}			18	115
Turn-Off Time (Note 4)		TA = +25°C		3	5	ns	
	toff	35pF; V _{NO} , V _{NC} = 3V; Figure 2	$T_A = T_{MIN}$ to T_{MAX}			6	115
Break-Before-Make (Note 4)	topu	t_{BBM} $C_L = 35pF; V_{NO} or$	TA = +25°C		8		
Dreak-Defore-Make (Note 4)	1		$T_A = T_{MIN}$ to T_{MAX}	1			ns
Charge Injection	Q	$V_{GEN} = 0$, $R_{GEN} = 0$, $C_L = 1$ nF, Figure 4			5		рС
NO, NC Off-Capacitance	C _{NO(OFF),} C _{NC(OFF)}	NO or NC = GND, $f = -$	NO or NC = GND, f = 1MHz, Figure 5				pF
Switch On-Capacitance	C _(ON)	f = 1MHz, Figure 5			34		pF
Off-Isolation (Note 6)		$C_L = 5pF, R_L = 50\Omega,$	f = 10MHz		-55		dB
	VISO	Figure 3	f = 1MHz		-80		
Crosstalk (Note 7)	I VCT I	$C_L = 5 pF, R_L = 50 \Omega,$	f = 10MHz		-62		dB
Clossiaik (Note 7)		Figure 3	f = 1MHz		-82		
Total Harmonic Distortion	THD	$R_L = 600\Omega$, 0.5Vp-p, f = 20Hz to 20kHz			0.018		%
SUPPLY				•			
Positive Supply Current	I+	$V_{+} = 5.5V, V_{IN} = 0 \text{ or } V_{+}$			0.001	1.0	μA

ELECTRICAL CHARACTERISTICS—Single +3V Supply

 $(V + = +2.7V \text{ to } +3.3V, V_{INH} = 2.0V, V_{INL} = 0.4V, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted}. Typical values are at T_A = +25°C.)$

PARAMETER	SYMBOL	CONDITIONS		MIN	ТҮР	MAX	UNITS
ANALOG SWITCH							
Analog Signal Range	V _{COM} , V _{NO} , VNC			0		V+	V
On Basistanca	Resistance $R_{ON} = \frac{V_{+} = 2.7V, I_{COM} = 10 \text{mA}, V_{NO} \text{ or}}{V_{NC} = 0 \text{ to } V_{+}}$	$T_A = +25^{\circ}C$		6	8	Ω	
On-nesistance			$T_A = T_{MIN}$ to T_{MAX}			9	52
On-Resistance Match	ABON = 10mA VNO or		$T_A = +25^{\circ}C$		0.1		Ω
Between Channels (Note 2)		$T_A = T_{MIN}$ to T_{MAX}			0.4		
On-Resistance Flatness		$V+ = 2.7V, I_{COM} = 10mA, V_{NO} or V_{NC} = 0 to V+$	$T_A = +25^{\circ}C$		1.5	3	Ω
(Note 3)			$T_A = T_{MIN}$ to T_{MAX}			3.5	22

ELECTRICAL CHARACTERISTICS—Single +3V Supply (continued)

(V+ = +2.7V to +3.3V, V_{INH} = 2.0V, V_{INL} = 0.4V, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25°C.)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
DIGITAL INPUTS							1
Input Logic High	VIH			2.0			V
Input Logic Low	VIL					0.4	V
Input Current	l _{IN}	V _{IN} = 0.4V or 2.0V		-0.1	0.005	0.1	μA
DYNAMIC							
Turn On Time (Nate 4)	tou	$R_L = 300\Omega; C_L =$	$T_A = +25^{\circ}C$		14	20	
Turn-On Time (Note 4)	ton	$35pF; V_{NO}, V_{NC} = 2V;$ Figure 2	$T_A = T_{MIN}$ to T_{MAX}			22	- ns
Turn Off Time (Nate 4)	$\begin{array}{c} R_{L}=300\Omega;C_{L}=\\ 35pF;V_{NO},V_{NC}=2^{N}\\ Figure\;2 \end{array}$		TA = +25°C		4	7.5	– ns
Turn-Off Time (Note 4)		1	$T_A = T_{MIN}$ to T_{MAX}			8	
	$ \begin{array}{c} R_L = 300\Omega; \ C_L\\ 35pF; \ V_{NO}, \ V_N\\ Figure \ 2 \end{array} $	$R_L = 300\Omega; C_L =$	TA = +25°C		8		
Break-Before-Make (Note 4)			$T_A = T_{MIN}$ to T_{MAX}	1			ns
Charge Injection	Q	$V_{GEN} = 0$, $R_{GEN} = 0$, $C_L = 1$ nF, Figure 4			5		рС
NO, NC Off-Capacitance	C _{NO(OFF)} , C _{NC(OFF)}	NO or NC = GND, $f = -$	NO or NC = GND, f = 1MHz, Figure 5		12		pF
Switch On-Capacitance	C(ON)	f = 1MHz, Figure 5			34		pF
Off-Isolation (Note 6)		$C_L = 5pF, R_L = 50\Omega,$	f = 10MHz		-55		dB
OII-ISOIALIOIT (NOLE 6)		Figure 3	f = 1MHz		-80		
Crosstalk (Note 7)	VCT	$C_L = 5 pF, R_L = 50 \Omega,$	f = 10MHz		-62		dB
CIUSSIAIN (INULE I)		Figure 3	f = 1MHz		-82		
SUPPLY							
Positive Supply Current	I+	$V_{+} = 3.3V, V_{IN} = 0 \text{ or } V_{+}$ 0.001 1.0		1.0	μA		

Note 2: $\Delta R_{ON} = R_{ON}(MAX) - R_{ON}(MIN)$.

Note 3: R_{ON} flatness is defined as the difference between the maximum and minimum value of on-resistance as measured over the specified analog signal range.

Note 4: Guaranteed by design.

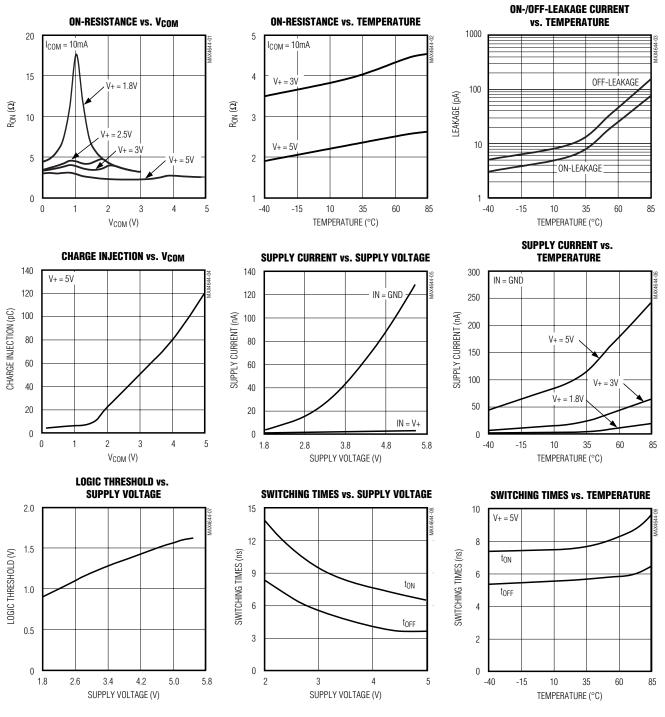
Note 5: On-Leakage performed with voltage applied to COM, with NO and NC left floating.

Note 6: Off-Isolation = $20\log_{10} (V_O / V_I)$, where V_O is V_{COM} and V_I is either V_{NC} or V_{NO} from the network analyzer.

Note 7: Crosstalk is measured between the two switches.

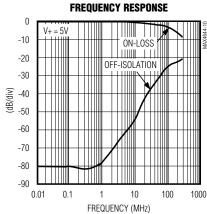
Typical Operating Characteristics

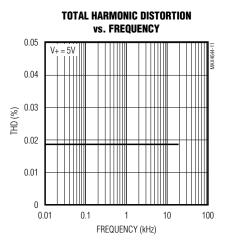
(V+ = +5V or +3V, VINH = V+, VINL = GND, TA = +25°C, unless otherwise noted.)



Typical Operating Characteristics (continued)

(V+ = +5V or +3V, V_{INH} = V+, V_{INL} = GND, T_A = +25^{\circ}C, unless otherwise noted.)

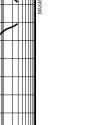




Pin Description

MAX4644		NAME	FUNCTION			
SOT23	μΜΑΧ		FUNCTION			
1	6	IN	Logic-Controlled Input			
2	4	V+	Positive Supply Voltage Input. Bypass with a 0.1µF capacitor to GND.			
3	3	GND	Ground			
	5, 7	N.C.	No Connection. Not internally connected.			
4	2	NC	Analog Switch Normally Closed Terminal			
5	1	COM	Analog Switch Common Terminal			
6	8	NO	Analog Switch Normally Open Terminal			

Note: The switches are bidirectional, which means that a signal can be passed through either side of the on switch. However, the typical off-capacitances differ as shown in the *Electrical Characteristics*.



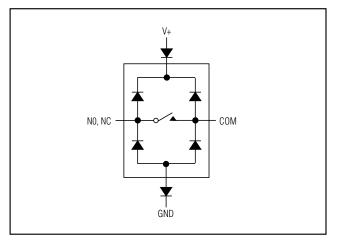


Figure 1. Overvoltage Protection Using External Blocking Diodes

Applications Information

The MAX4644 operates from a single supply ranging from +1.8V to +5.5V. The device is guaranteed to be functional over that supply range, but TTL/CMOS compatibility is only valid for operation using a +5V supply. All voltage levels are referenced to GND. Positive and negative DC analog inputs or AC signals can be accommodated by shifting V+ and GND.

ESD-protection diodes are internally connected between each analog-signal pin and both V+ and GND. One of these diodes conducts if any analog signal exceeds V+ or GND (Figure 1). Virtually all of the analog leakage current comes from the ESD diodes to V+ or GND. Although the ESD diodes on a given signal pin are identical, and therefore fairly well balanced, they are reverse biased differently. Each is biased by either V+ or GND and the analog signal. This means their leakages will vary as the signal varies. The difference in the two diode leakages to the V+ and GND pins constitutes the analog-signal-path leakage current. All analog leakage current flows between each pin and one of the supply terminals, not to the other switch terminal. This is why both sides of a given switch can show leakage currents of the same or opposite polarity.

There is no normal current path between the analogsignal paths and V+ or GND. V+ and GND also power the internal logic and logic-level translators. The logiclevel translators convert the logic level into switched V+ and GND signals to drive the analog signal gates.

Chip Information

TRANSISTOR COUNT: 105



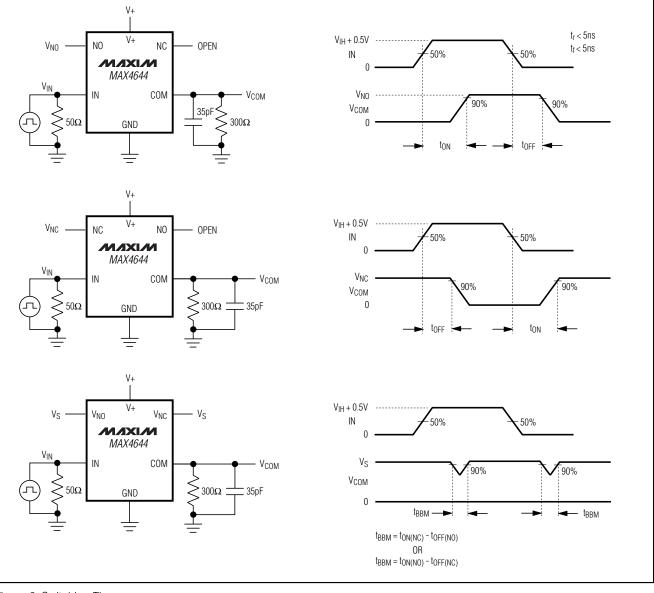


Figure 2. Switching Times

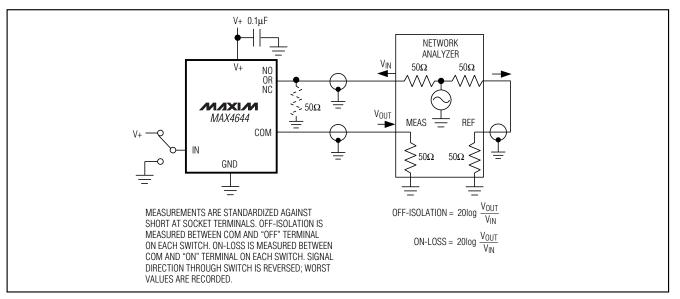


Figure 3. Off-Isolation and On-Loss

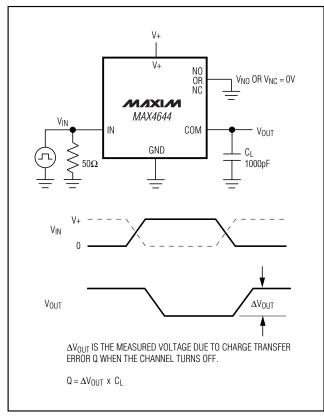


Figure 4. Charge Injection



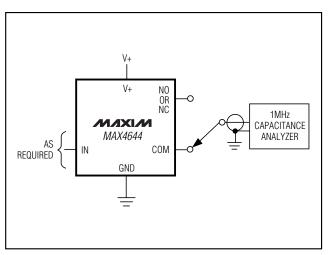
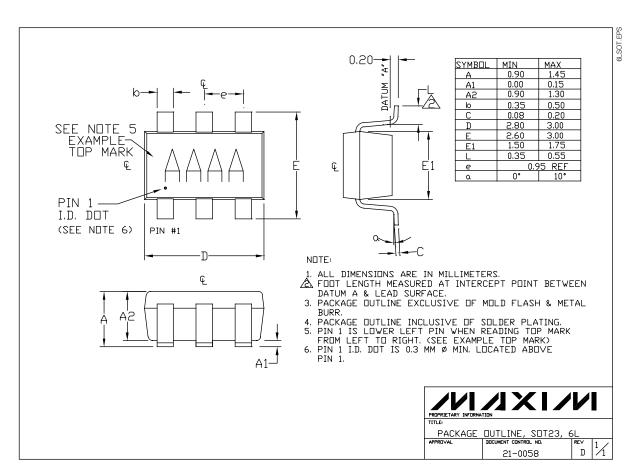


Figure 5. NO, NC, and COM Capacitance

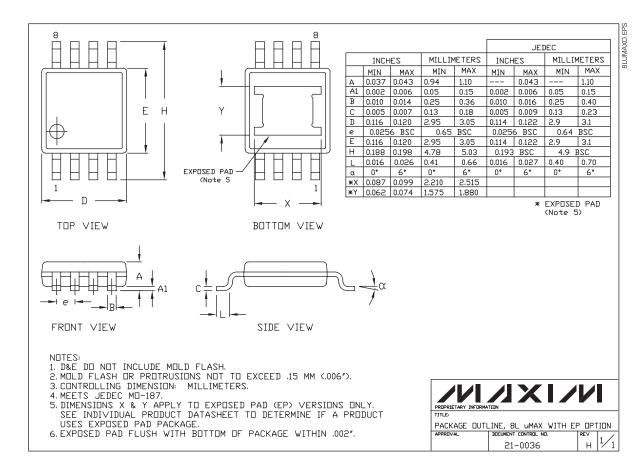






Package Information

_Package Information (continued)



NOTES

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